




- A1/B1** EMS Electronic manufacturing services, PCBs and other circuit carriers
- A2 B2-3** Electromechanics and system peripherals, Interconnection components
- A2** Electromechanics and system peripherals, Interconnection components, Relays, switches and keyboards
- B3** Electromechanics and system peripherals, Interconnection components, Casing technology
- C6** EMS Electronics manufacturing services, PCBs and other circuit carriers, Electromechanics and system peripherals
- A3** Test and measurement
- A4** Power supplies
- A5-6** Passive components
- B3** Sensor technology, Micro- and nanosystems (NEMS, MEMS)
- B4** **all halls** Embedded systems
- B4-5 C3-5** Semiconductors
- B6** Displays
- B6** **all halls** Automotive
- B6** Wireless
- C1-2** SEMICON Europa 2024 
- all halls** ED/EDA / Servo-technology / Assemblies and subsystems / Services
- ICM** **Conferences**
 - electronica Automotive Conference
 - Wireless Congress

- SEMICON Europa Conferences**
- MEMS & Imaging Sensors Summit
 - Fab Management Forum (FMF)
 - Advanced Packaging Conference (APC)

- Forums**
- A1: PCB, EMS & Components Marketplace**
 - PCB, EMS & Components
 - Printed Electronics by LOPEC & OE-A
 - A4: electronica Stage**
 - Electrical Connectors
 - Measurement Technology
 - A5: Power Efficiency Stage**
 - Embedded Systems
 - Power Electronics
 - B4: Start-up Stage** 
 - electronica Fast Forward
 - B4: Visionary Stage**
 - Cyber Security
 - Industrial IoT: AI/Machine Learning, 5G & Edge Computing
 - Women in Tech
 - B6: Smart Mobility Stage**
 - Automotive
 - Printed Electronics by LOPEC & OE-A
 - C5: Future Control Stage**
 - Embedded Platforms
 - Industrial Control
 - SEMICON Europa Forums**
 - SEMICON Europa TechARENA (C1)
 - SEMICON Europa Executive Forum (C2)



components | systems | applications | solutions
 World's leading trade fair and conference for electronics
 Trade Fair Center Messe München | November 12-15, 2024
 electronica.de